

The Source

A weekly newsletter for members of the
Electronic Components Industry Association.



Thursday, October 4, 2018

[Executive Conference](#)

October 21-23, 2018

Chicago, IL

[Weekly Economic Trends](#)

[National Association of
Manufacturers](#)

Chief economist Chad Moutray provides weekly analysis of key U.S. government economic data and manufacturing industry trends in the [Monday Economic Report](#).

Key Links

www.ecianow.org

www.eciaauthorized.com



ECIA Executive Conference



ECIA Reorganization Better Serves Your Unique Needs

Bill Bradford Announces Exciting Changes



Upon joining ECIA as president and CEO at the beginning of the year, I met with many of our members and potential members to assess what they valued of our current offering and what might be changed or added to enhance membership in the Association. My personal discussions were followed by the launch of a Spring 2018

Member Survey and a series of in-depth interviews. These gave me and the Executive Committee additional valuable insights and several things became quite apparent. [Read the complete announcement.](#)

Provide Guidance to the U.S. Department of Defense (DoD)

Free Workshop + Confidential Survey

Association Connecting Electronics Industries



ECIA has partnered with IPC to provide guidance to the U.S. Department of Defense (DoD) regarding the state of the U.S.

defense industrial base and what changes may be necessary to keep our country and the electronics supply chain secure. The feedback provided by ECIA and IPC will be used by DoD to write a report to Congress regarding the National Defense Strategy. Your input is crucial!

ECIA needs your assistance in two ways:

First, please complete a confidential survey by **October 5**. The survey will take about 12 minutes to complete. Respondents and their companies will not be identified in any reports or comments to the DoD. You are encouraged to forward this message to others at your company who are able to respond. [Click here to take the survey.](#)

Second, [register for a FREE ECIA-IPC industry workshop](#) to be held on October 19 in Bannockburn, IL (Chicago). The goal of the workshop is to provide DoD representatives in attendance with feedback on specific questions regarding the manufacturing of electronic components in the U.S. and its implications for national security. Among the likely issues to be addressed are counterfeiting,



obsolescence, and lead times. There will be four workshops focusing on the challenges and opportunities facing these key segments of the industry:

- Assembly/EMS
- Printed Circuit Board
- Cable and Connectors
- Passive Components

Please [register for the workshop](#) and lend your voice to these efforts.

ECIA strongly encourages manufacturers of connectors and passive components to complete the survey and to register for this event. If you have any questions, please contact [Robin Gray](#) at rgray@ecianow.org.

September TPC Survey: Orders and Inventory Forecast

September Survey Results Show Some Weakening Demand



ECIA recently expanded its industry data offering with a monthly trends report on the electronic components industry. The report provides results from a survey sent to 20,000 electronic industry professionals across the globe to assess their expectations for order activity and inventory levels.

[Click here](#) to view the September 2018 report.

This survey has been conducted for two years by Technology Partners Consulting, which provides independent third-party consulting to electronics suppliers and financial services firms. The survey is administered by Glenn Hitchcock, TPC founder and president, who has an extensive 30-year background in the Semiconductor Industry. We welcome member input and feedback on this monthly report, and on additional information you would like to receive. Contact [Jim Bruorton](#) with your comments.

Fall Engineering Summit Results in New Standards Projects

Your Participation is Encouraged



The 2018 Fall Engineering Summit took place in Nashville, TN last week and as a result of the meetings, 9 new standards projects were opened. The Engineering

Summit Committees are specifically seeking additional participation by the User category. This typically includes, but is not limited to, OEMs, ODMs, Contract Manufacturers, and Electronics Distributors. There are 2 face-to-face meetings each year, with the option of Webex conferencing for those unable to travel. The new projects include:

- **PN-5424:** Revise EIA-809 Solid Tantalum Capacitor Application Guideline
- **PN-5425:** Revision or Reaffirmation of EIA-717-A Surface Mount Tantalum Capacitor Qualification Specification
- **PN-5426:** Technical Review of IS-692 Ceramic Capacitor Qualification Specification
- **PN-5427:** Technical Review of EIA-521-A Application Guide For Multilayer Ceramic Capacitors - Electrical
- **PN-5428:** Technical Review of EIA-971 4 mm Embossed Carrier Taping of Micro-Sized Surface Mount Components for Automatic Handling
- **PN-5429:** Technical Review of EIA-747-B Adhesive Backed Punched Plastic Carrier Taping of Singulated Bare Die and Other Surface Mount Components for Automatic Handling of Devices Generally Less Than 1.0mm Thick
- **PN-5430:** Technical Review of EIA-481-E 8 mm Through 200 mm Embossed Carrier Taping and 8 mm & 12 mm Punched Carrier Taping of Surface Mount Components for Automatic Handling
- **PN-5431:** Withdrawal of EIA-705 Electronic Industries Association - Automated Component Handling Committee - Guidelines and Procedures for Registration of New Technologies for Automated Component Handling for Publication in ACH-2000
- **PN-5432:** Withdrawal of EIA-726 8 mm Punched & Embossed Carrier Taping of Surface Mount Components for Automatic Handling of Devices Generally Smaller Than 2.0 mm x 1.2 mm and EIA-763 Bare Die and Chip Scale Packages Taped in 8 mm & 12 mm Carrier Tape for Automatic Handling

Participation in the ECIA standards program is open to all individuals who are directly and materially affected by matters addressed by the work. Please direct any questions concerning the program to [Edward F. Mikoski, Jr.](#), Vice President of Standards and Technology: 571-323-0253.

Did You Know?

Members Have Exclusive Opportunities to Participate on ECIA Committees



As a member, you have many opportunities to join ECIA committees based on your interests. Choose from: [Marketing](#), [Statistics and Industry Data](#), [EIA Standards](#), and [Global Industry Practices](#).

Create new friendships while making a positive impact in the industry. We need you! Learn more about the different councils and how to get involved [here](#). For general inquiries, please call ECIA at: 678-393-9990

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